



Getting Started with Icepak: Toolkits



ANSYS, Inc.
Southpointe
2600 Ansys Drive
Canonsburg, PA 15317
ansysinfo@ansys.com
<https://www.ansys.com>
(T) 724-746-3304
(F) 724-514-9494

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Conventions Used in this Guide

Please take a moment to review how instructions and other useful information are presented in this documentation.

- Procedures are presented as numbered lists. A single bullet indicates that the procedure has only one step.
- Bold type is used for the following:
 - Keyboard entries that should be typed in their entirety exactly as shown. For example, “**copy file1**” means you must type the word **copy**, then type a space, and then type **file1**.
 - On-screen prompts and messages, names of options and text boxes, and menu commands. Menu commands are often separated by greater than signs (>). For example, “click **HFSS > Excitations > Assign > Wave Port.**”
 - Labeled keys on the computer keyboard. For example, “Press **Enter**” means to press the key labeled **Enter**.
- Italic type is used for the following:
 - Emphasis.
 - The titles of publications.
 - Keyboard entries when a name or a variable must be typed in place of the words in italics. For example, “**copy filename**” means you must type the word **copy**, then type a space, and then type the name of the file.
- The plus sign (+) is used between keyboard keys to indicate that you should press the keys at the same time. For example, “Press Shift+F1” means to press the **Shift** key and, while holding it down, press the **F1** key also. You should always depress the modifier key or keys first (for example, Shift, Ctrl, Alt, or Ctrl+Shift), continue to hold it/them down, and then press the last key in the instruction.

Accessing Commands: *Ribbons*, *menu bars*, and *shortcut menus* are three methods that can be used to see what commands are available in the application.

- The *Ribbon* occupies the rectangular area at the top of the application window and contains multiple tabs. Each tab has relevant commands that are organized, grouped, and labeled. An example of a typical user interaction is as follows:

"Click **Draw > Line**"



This instruction means that you should click the **Line** command on the **Draw** ribbon tab. An image of the command icon, or a partial view of the ribbon, is often included with the instruction.

- The *menu bar* (located above the ribbon) is a group of the main commands of an application arranged by category such File, Edit, View, Project, etc. An example of a typical user interaction is as follows:

"On the **File** menu, click the **Open Examples** command" means you can click the **File** menu and then click **Open Examples** to launch the dialog box.

- Another alternative is to use the *shortcut menu* that appears when you click the right-mouse button. An example of a typical user interaction is as follows:

"Right-click and select **Assign Excitation> Wave Port**" means when you click the right-mouse button with an object face selected, you can execute the excitation commands from the shortcut menu (and the corresponding sub-menus).

Getting Help: Ansys Technical Support

For information about Ansys Technical Support, go to the Ansys corporate Support website, <http://www.ansys.com/Support>. You can also contact your Ansys account manager in order to obtain this information.

All Ansys software files are ASCII text and can be sent conveniently by e-mail. When reporting difficulties, it is extremely helpful to include very specific information about what steps were taken or what stages the simulation reached, including software files as applicable. This allows more rapid and effective debugging.

Help Menu

To access help from the Help menu, click **Help** and select from the menu:

- **[product name] Help** - opens the contents of the help. This help includes the help for the product and its *Getting Started Guides*.
- **[product name] Scripting Help** - opens the contents of the *Scripting Guide*.
- **[product name] Getting Started Guides** - opens a topic that contains links to Getting Started Guides in the help system.

Context-Sensitive Help

To access help from the user interface, press **F1**. The help specific to the active product (design type) opens.

You can press **F1** while the cursor is pointing at a menu command or while a particular dialog box or dialog box tab is open. In this case, the help page associated with the command or open dialog box is displayed automatically.

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1 - Introduction

Toolkits provide means to automate routine tasks and help maximize efficiency of project workflows. The Ansys Electronics Desktop offers an array of Icepak toolkits organized by geometry creation, modeling, and productivity. This document is intended as supplementary material to Icepak for beginners and advanced users. It includes instructions to use the Icepak Create PGBA toolkit to create the model and Extract JB and JC toolkit to solve the model and extract the theta JB value.

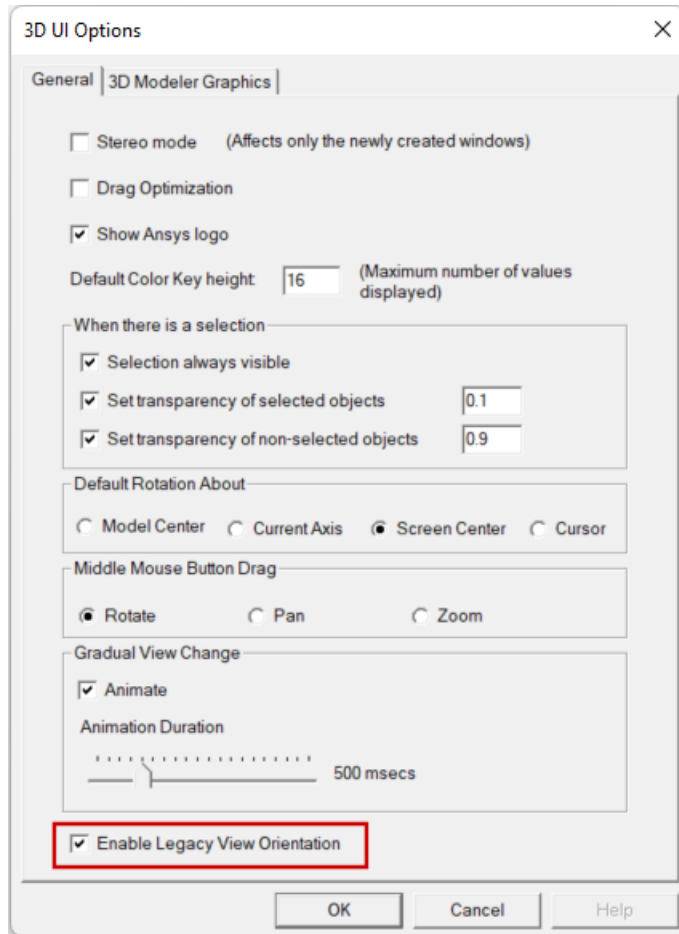
Set 3D UI Options

Ensure that the new view orientation scheme introduced in release 2024 R1 is not being used, since the instructions and images in this guide are based on the legacy orientation scheme.

1. From the menu bar, click **View > Options**.

The *3D UI Options* dialog box appears.

2. Ensure that **Enable Legacy View Orientation** is enabled:



3. Click **OK**.

2 - Set Up the Project

Launch the Ansys Electronics Desktop

A shortcut of the Ansys Electronics Desktop application appears on your desktop once the application is installed.

1. On the **Desktop** ribbon tab, click **Icepak** to insert an Icepak design in the project.

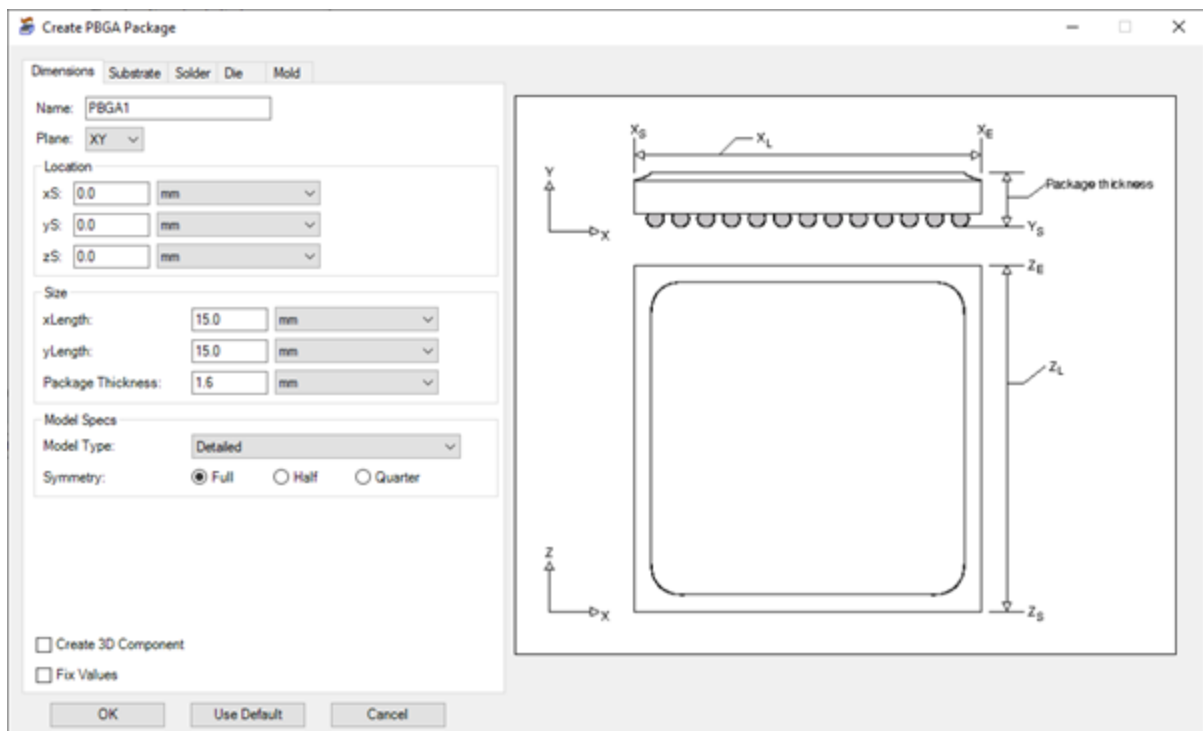
Note: You can hide the grid by selecting **View > Grid Settings** and then selecting **Hide** in the **Grid Spacing** dialog box. Also, from the **View > Coordinate Systems** menu, you can hide the large coordinate triad and display a smaller coordinate triad in the bottom of the **3D Modeler** window.

2. From the **File** menu, select **Save As**, and save the project in the desired working directory.

Create a PBGA Package

The PBGA toolkit provides capabilities to create a standard Integrated-Circuit Plastic Ball Grid Array (PBGA) Package. You can find the 2D blueprints on the right side of most Geometry toolkits. Geometry Package toolkits provide the ability to specify dimensions and properties to create standard IC packages.

1. From the **Icepak** menu, select **Toolkit > Geometry > Packages > PBGA**.

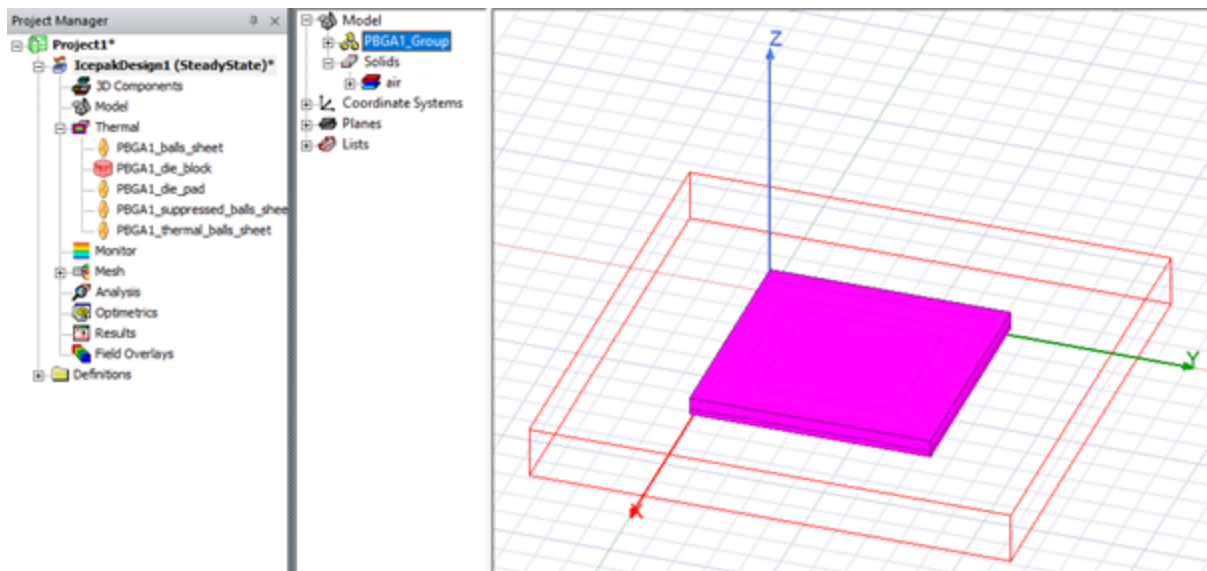


2. Under **Model Specs**, change the **Model Type** to **Compact Conduction Model (CCM)**.

Note:

Most Icepak Geometry toolkits have a Compact Conduction Model (CCM) option that provides the ability to create a simplified version of the package. The solder ball array in PBGA is approximated as a solid covering the bottom surface of the package with equivalent uniform material properties. Additional approximations of this type are made leading to decreases in the complexity of the model. It is suggested that the user compare the detailed and CCM packages of a geometry toolkit.

3. On the **Solder** tab under **Distribution**, define the following settings:
 - Change the **Array Type** to **Peripheral Array**.
 - Change the **Number of Suppressed Rows** to **X = 6** and **Y = 6**.
 - Change the **Number of Central Rows** to **X = 4** and **Y = 4**.
4. On the **Die** tab under **Die Attach**, change the **Material** to **Si-Typical**.
5. Click **OK** to create the PBGA package.



3 - Analyze and Extract Theta JB

Use the Extract Theta JB and Theta JC toolkit to solve the model determine the Theta Junction-to-board and/or Theta Junction-to-case value.

Note:

The toolkit also provides the ability to load an existing solution to determine the theta values for post-processing.

1. From the **Icepak** menu, select **Toolkit > Modeling > IC Packages > Extract_JB_JC**.

Extract Theta_JB and Theta_JC

Select Design: IcepakDesign1

Options

- ☒ Solve and extract Theta_JB, Theta_JC
- ☐ Post-processing only (Load an existing solution and extract Theta_JB or Theta_JC)

Package Information

Package Top Side: MaxZ

Package type: ☒ Array ☐ Leaded

Ambient Temperature: 20.0 cel

Thermal Characterization

☐ Theta_JC ☒ Theta_JB ☐ Both

Theta_JC Inputs

Package Top Surface Area: 2.5e-5 m2

Heat Transfer Coefficient on Top Wall: 100000 w_per_m2kel

Theta_JB Inputs

Monitor Point for Board Temperature: ☒ Automatic Creation ☐ Manual Creation

PCB information for Theta_JB: ☒ Simple (FR-4) ☐ Detailed (JEDEC 2s2p)

A simple FR-4 PCB will be created automatically

Select Existing Solution

Setup Name:

Simulation Settings

Run the simulation in: ☐ Active ☒ Serial ☐ Parallel 2 tasks

*For more information on this macro, please click the Help button

Accept Reset Cancel Help

2. Under **Options**, ensure that **Solve and extract Theta_JB, Theta_JC** is selected.
3. Under **Package Information**, select **MaxZ** from the **Package Top Side** drop-down list.
4. For **Package Type**, ensure that **Array** is selected.
5. Under **Thermal Characterization**, select **Theta_JB**.

6. Under **Theta_JB Inputs**, ensure that **Simple (FR-4)** is selected.

Note:

When using the Theta_JB radio option, the Extract Theta JB and Theta JC toolkit automatically creates a PCB under which the IC package sits. You can specify the type to be either a simple FR-4 material PCB or a detailed JEDEC 2s2p PCB.

7. Click **Accept** to start the analysis. When the analysis is complete, a dialog displays the theta JB value.

